## Electronic Filing System (EFS) Data Electronic Patent Application Submission USPTO Use Only

EFS ID:

14959

Application ID:

10063572

Title of Invention:

WAFER LEVEL PACKAGING AND

**CHIP STRUCTURE** 

First Named Inventor:

Chi-Hsing Hsu

Domestic/Foreign Application:

**Domestic Application** 

Filing Date:

null

**Effective Receipt Date:** 

2002-05-03

Submission Type:

**Utility Patent Filing** 

Filing Type:

îIJ

new-utility

**Confirmation Number:** 

0

**Attorney Docket Number:** 

8289-US-PA

Digital Certificate Holder:

cn=Belinda Lee, ou=Registered Attorneys, ou=Patent and Trademark Office, ou=Department of Commerce, o=U.S.

Government, c=US

Certificate Message Digest:

YUG1TywVS36WAX9NAACAhg==

**Total Fees Authorized:** 

\$864.0

**Payment Category:** 

CC - Credit Card

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**Electronic Version 1.0.3** 

Stylesheet Version: 1.0

Attorney Docket

8289-US-

Number:

PA

Submission Type: Utility Patent

**Filing** 

## WAFER LEVEL PACKAGING AND CHIP STRUCTURE

First Named Inventor: Mr. Chi-Hsing Hsu

SUBMITTED BY

Name:

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JI

Miss BELINDA LEE

Registration Number:

46863

Electronic Signature Mark: /BL

Date Signed: 20020503

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Attached Files:

declaration

8289declaration1.tif

declaration

8289declaration2.tif

bibd-transmittal

8289usapds.xml

patent-assignments

8289usasgn.xml

fee-transmittal specification

8289usfee.xml 8289usf.xml

Attached Image File(s): 8289declaration1.tif 8289declaration2.tif



Electronic Version 1.1.0 Stylesheet Version: 1.0

Patent fees are subject to annual revisions on or about October 1st of each year.

Large Entity

**TOTAL FEES AUTHORIZED: \$864** 

ы BANK (CREDIT) CARD INFORMATION:

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BASIC FILING FEE

Fee Description	Fee Code	Fee Paid	
Utility Filing Fee	101	\$ 740	

Subtotal For Basic Filing Fee: \$ 740

## **EXTRA CLAIM FEES**

	Fee Code	Fee	Extra Claims	Fee Paid
Total Claims: 20	103	\$ 18	0	\$ O
Independent Claims: 4	102	\$ 84	1	\$ 84

Subtotal For Extra Claims Fees: \$ 84

## **ADDITIONAL FEES**

Fee Description	Number	Quantity	Fee Code	Amount	Fee Paid
Recording Each Patent Assignment Per Property Fee	00000000	1	581	\$ 40	\$ 40

Subtotal For Additional Fees: \$ 40

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